

Since $\delta p(x=0) = \Delta P$ is maintained constant,
→ Steady state. So use Steady-state equations.

Solution to 2nd-order differential equations
have the form:

$$\delta p(x) =$$

Evaluate C_1 and C_2 from boundary conditions

$$\delta p(x=\infty) = 0 \quad \text{so } C_1 = 0$$

$$\delta p(x=0) = \Delta P \quad \text{so } C_2 = \Delta P$$

so $\delta p(x) =$

and L_p = length over which Δp decays to $\Delta p e^{-1}$
and $p = p_0 + \Delta p e^{-x/L_p} = p_0 + \delta p(x)$



Diffusion current decays too. Since

$$J_p = \boxed{} \\ = \boxed{}$$

proportional to excess
carriers

Actually, very important for p-n junctions
→ injection of minority carriers across junctions

Recombination Probability

$$S_P(x) = \Delta P e^{-x/L_P}$$

Probability that hole survives to x without recombination is:

$$\frac{S_P}{\Delta P} = e^{-x/L_P}$$

Probability that hole recombines in subsequent interval dx is:

$$\frac{S_P(x) - S_P(x+dx)}{S_P(x)} = -\left(\frac{dS_P(x)}{dx}\right) \frac{dx}{S_P(x)} = \frac{1}{L_P} \cdot dx$$

Total probability that hole injected at $x=0$ recombines in given dx is product of probabilities:



$$\text{average distance } \langle x \rangle = \int_0^{\infty} \frac{x}{L_p} e^{-x/L_p} dx = L_p$$

$$\text{since } \int x e^{ax} dx = \frac{e^{ax}}{a^2} (ax - 1) \quad \text{where } a = -\frac{1}{L_p}$$

$$\frac{e^{-x/L_p}}{(-\frac{1}{L_p})^2} \left(-\frac{x}{L_p} - 1\right) \Big|_0^{\infty} = L_p^2 \text{ at } x=0$$

$$\text{so } \langle x \rangle =$$

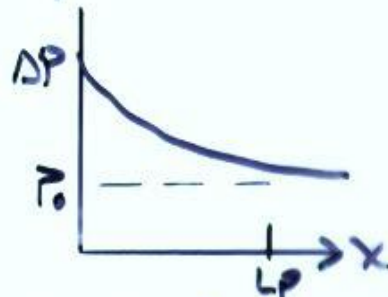


In jected Current and Stored charge

$$I_p = -g A D_p \frac{dp}{dx} = g A \frac{D_p}{L_p} \Delta p e^{-x/L_p}$$

current changes with x !

$$Q_p = g A \int_0^{\infty} \Delta p e^{-x/L_p} dx$$



=



Diffusion length memory device:
small animals crossing Amazon - piranha

Example: Solve for L_p where the bar is
Si, $N_A = 10^{15}/\text{cm}^3$, $\tau_p = 10^{-6} \text{ sec}$

$$L_p = \boxed{} \quad \text{state-state diffusion}$$

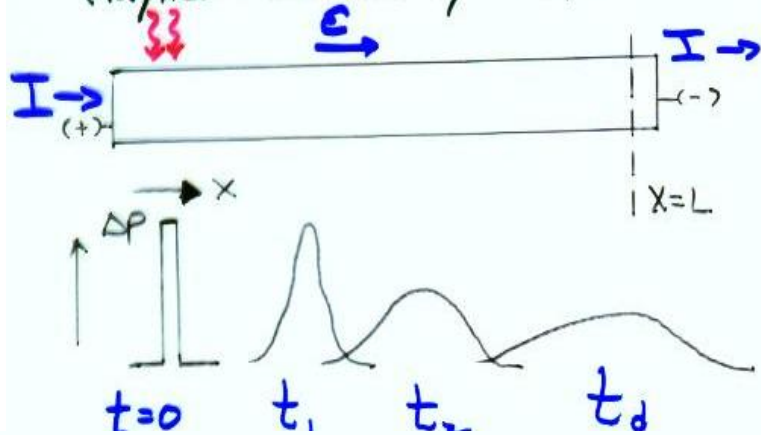
$$= \boxed{} \quad \text{Einstein relation}$$

$$= \left[\underbrace{(0.0259 \text{ V})}_{\substack{\text{" } kT(300\text{K}) \\ q}} \underbrace{(458 \text{ cm}^2/\text{V-sec})}_{\substack{\text{Fig. 3-23}}} (10^{-6} \text{ sec}) \right]^{1/2}$$

$$\approx \boxed{}$$

Independent of ΔP (or doping) ~ + of ΔP is not of ΔP depends on doping

Haynes-Schockley Experiment



Measure μ and D independently

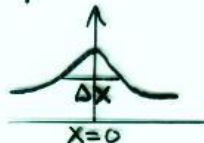
$\mu =$

But pulse spreads out.

Measure D from the spread

Diffusion Equation
neglecting recombination
 T_p

$$S_p(x, t) = \left[\frac{\Delta p}{2\sqrt{\pi D_p t}} \right] e^{-x^2/4D_p t}$$



$$D_p = \frac{(\Delta x)^2}{16 t_d}$$

Gaussian
Distribution

D_p is a constant, so
as t_d increases, so

Read S&B 4.4.5

Gradients of Fermi Levels

Relate currents to quasi- E_F gradients

Equilibrium: $\frac{dE_F}{dx} = 0 \rightarrow J = 0$

Non equilibrium: $J \neq 0$

$$J_n(x) = q \mu_n n(x) E(x) + q D_n \frac{dn(x)}{dx}$$

$$n(x) =$$

(definition)

$$\left[\frac{dF_n}{dx} - \frac{dE_i}{dx} \right]$$

$$= \frac{n(x)}{KT} [\dots]$$

(Einstein)

$$J_n(x) = q \mu_n n(x) E(x) + n(x) \mu_n \left[\frac{dF_n}{dx} - \frac{dE_i}{dx} \right]$$

$$E(x) = \frac{1}{q} \left(- \frac{dE_i}{dx} \right)$$

=

Net effect of
drift and diffusion

(Likewise for holes)

Modified Ohm's Law:

$$J_n(x) = q \mu_n n(x) \frac{d(F_n/q)}{dx} = \sigma_n(x) \frac{d(F_n/q)}{dx}$$

$$J_p(x) = q \mu_p p(x) \frac{d(F_p/q)}{dx} = \sigma_p(x) \frac{d(F_p/q)}{dx}$$

Gradients \rightarrow Currents (J)

No " \rightarrow No " (J)

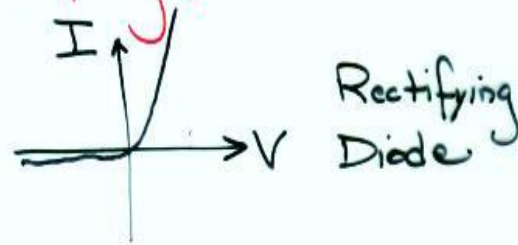
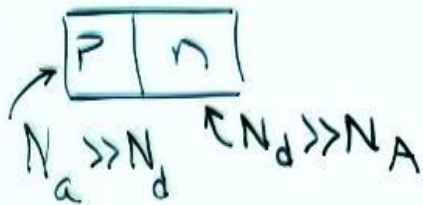
No J \rightarrow No gradient

Junctions

So far: Generation, Recombination
Drift, Diffusion, Diffusion Length

What happens if we intentionally set up
carrier gradients?

Instead of uniform doping, have



How to fabricate?

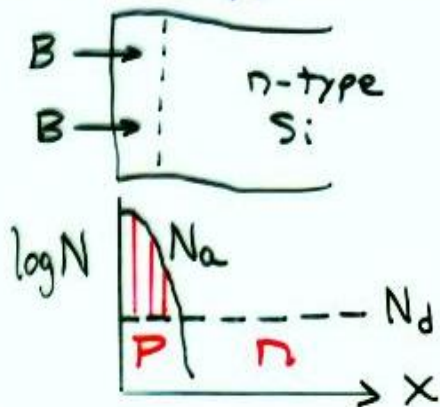
Read Streetman §5.1

5.1 Fabricate p-n junctions (ECE 5037!)

5.1.1 Grown junctions (change doping in mid-growth)
More flexible methods today.
with epitaxial growth, can still change on monolayer scale.

5.1.2 alloyed Junctions (regrowth)

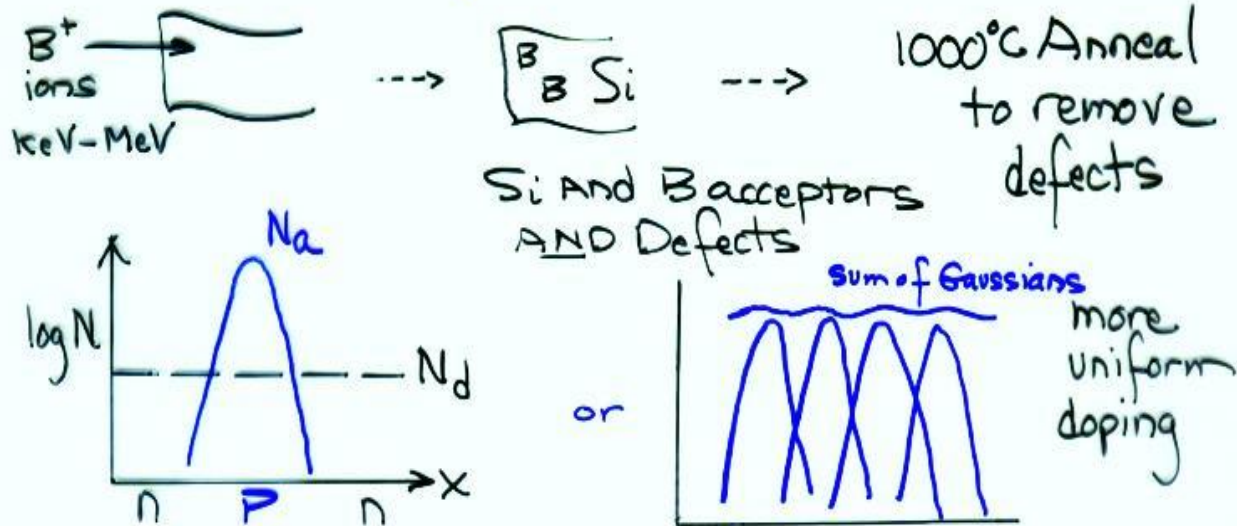
5.1.3 Diffused Junctions



Si: Vacancies at 1000°C
B atom moves in.

p-type where $N_a > N_d$.

5.1.4 Ion Implantation

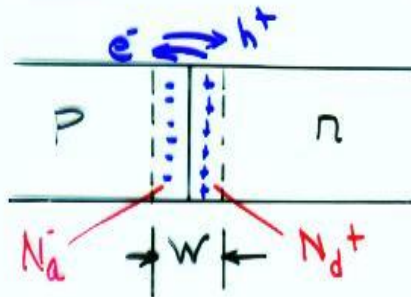
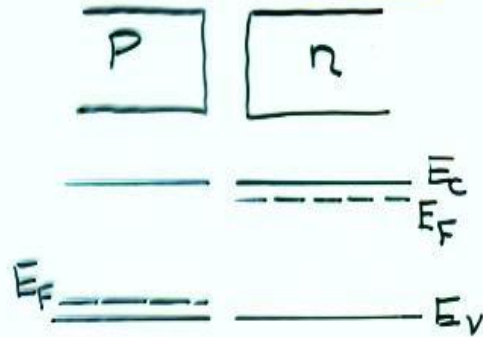


5.2 Equilibrium Conditions

- Step Junctions (versus diffused, graded)
 - \rightarrow Simplifies the math: get the "big picture", make corrections later

Will see: 4 Currents balance to zero
p-type drift, diffusion, n-type drift, diffusion
Applied bias unbalances them.

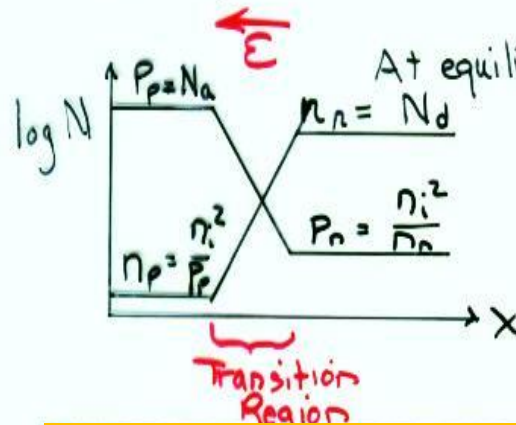
5.2.1 The Contact Potential



h^+ diffuses \rightarrow

e^- diffuses \leftarrow

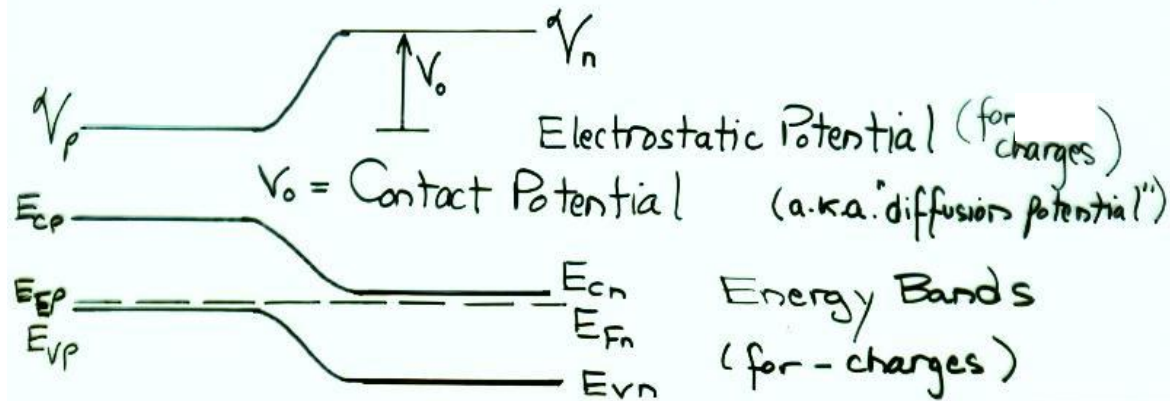
E set up \leftarrow
to balance diffused charge



At equilibrium, E extends over width w .



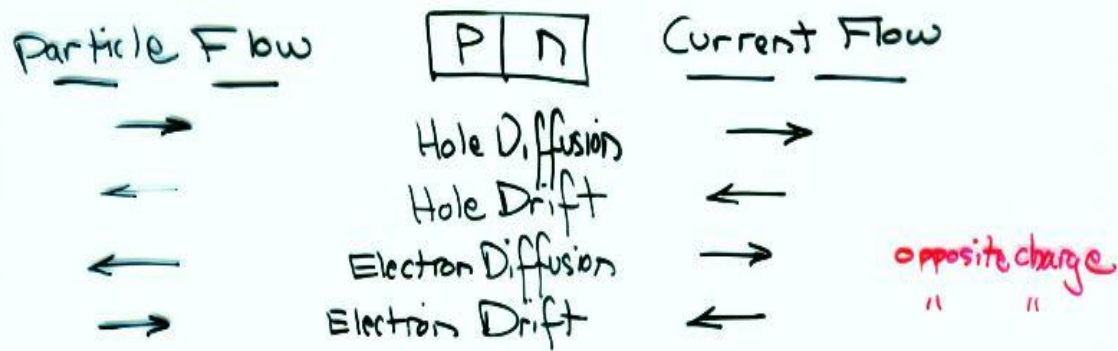
Gives n and p
on both sides of the junction



Major Big Deal! *!

e^- 's and h^+ 's diffuse and set up E and V_0 .

E_F 's align.



For each carrier, drift balances diffusion.
Setup by electric field E .

Can get V_0 from dopant concentration and
balance between drift and diffusion

$$J_p = 0 = q \left[\mu_p p(x) E(x) - D_p \frac{dp(x)}{dx} \right]$$

$$\frac{\mu_p}{D_p} E(x) = \frac{1}{p(x)} \frac{dp(x)}{dx}$$

$$E(x) = - \frac{dV(x)}{dx}$$

Subscript
denotes carrier

Einstein Relation

$$\frac{-q}{kT} \frac{dV(x)}{dx} = \frac{1}{p(x)} \frac{dp(x)}{dx}$$

Integrate across transition region

$$\int_{V_p}^{V_n} -\frac{q}{kT} \frac{dV(x)}{dx} dx = \int_{P_p}^{P_n} \frac{1}{P} \frac{dP}{dx} dx$$

$$-\frac{q}{kT} (V_n - V_p) = -\frac{q}{kT} V_0 = \ln \frac{P_n}{P_p}$$

$$P_p = N_a$$

$$P_n = \frac{n_i^2}{N_d}$$

$N_a = P_p$ $N_d = n_n$
majority concentration
~ doping concentration
(good except when $N_a \sim N_d$)



Very Valuable for I-V calculations
(V_0 measured by forward bias to flat bands)

Alternate Form :



$$n_p p_p = n_i^2 = p_n n_n$$

$$\therefore \frac{p_p}{p_n} = \frac{n_n}{n_p}$$

Check out Example 5.1 Get V_0 2 ways.

(Easier way is $\frac{N_a N_d}{n_i^2}$)